



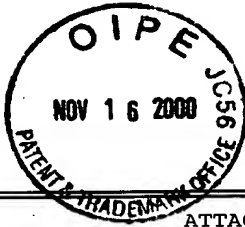
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FORM PTO-1449 (Modified) (Rev. 7-80)		U.S. Dept. of Commerce Patents and Trademark Office		Atty Docket No. SONY-T0964 (S00P0964US00)		Appln. No. 09/636,053	
INFORMATION DISCLOSURE CITATION  (Use several sheets if necessary)				Applicant(s) GORO FUJITA		Group 2653	
				Filing Date August 10, 2000			
U.S. PATENT DOCUMENTS							
*Examiner Initials		Document Number	Date	Name	Class	Subclass	Filing Date
10/11	AA	5,602,810	02/11/97	HORIMAI ET AL.	369	44.34	10/04/95
10/11	AB	5,606,545	02/25/97	HORIMAI ET AL.	369	124	09/21/95
10/11	AC	5,633,854	05/27/97	HORIMAI ET AL.	369	124	08/17/94
10/11	AD	5,684,783	11/04/97	HORIMAI ET AL.	369	124	08/17/94
FOREIGN PATENT DOCUMENTS							
*Examiner Initials		Document Number	Date	Country	Class	Subclass	Translation YES NO
OTHER DOCUMENTS							
Examiner  Nabil H. Haddad				Date Considered  6/24/02			
* Examiner: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.							

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ATTACHMENT A

LIST OF U.S. PATENT APPLICATIONS

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In accordance with MPEP § 609 C(2), the Examiner is respectfully requested to consider the listed applications and indicate on Attachment A that the listed applications have been considered.

Atty. Docket No. SONY-T0964	Appln. No. 09/636,053	Applicant(s) GORO FUJITA	Filing Date August 10, 2000	Group 2452-2653
*Examiner Initials RJA	U.S. PATENT APPLICATIONS		FILING DATE	
AE	U.S. PATENT APPLICATION NO.: 08/990,878		December 15, 1997	
Examiner Nabil Hinds			Date Considered 6/24/02	
* Examiner: Initial if application considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.				

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